

Dual-core, highly secure, multiprotocol wireless MCU

K32W0x MCUs for Wireless IoT Applications

The K32W0x platform, representing the next-generation of Kinetis MCUs, is the second multi-protocol offering in NXP's connectivity portfolio. This platform bridges its predecessor parts by providing a scalable path with higher performance, added functionality and increased security to address the evolving IoT landscape.

TARGET APPLICATIONS

- Smart home
 - Door locks
 - Smart thermostats
 - Lighting control
 - Security systems
- Building automation
 - Security and access control
 - Building control and monitoring
 - Building HVAC control
 - Fire/security
- Healthcare
 - Wearables
 - Fitness monitoring
 - Home healthcare

OVERVIEW

The K32W0x wireless MCU platform includes a high performance Arm[®] Cortex[®]-M4 processor and a low power Cortex-M0+ processor, ideal for applications that require a host MCU and a multi-protocol MCU. With 1.25 MB Flash and 384 kB SRAM, the K32W0x offers ample memory to fit both application firmware and wireless connectivity stacks in a small-form factor, low power, highly secure design.

Integrating a Bluetooth 5 radio, supporting up to 8 simultaneous connections, and an IEEE® 802.15.4 radio, capable of running the Thread mesh networking protocol, the K32W0x can support standalone protocols or multiple protocols running concurrently on a single chip. Multiprotocol running on a single chip eliminates the need for multiple radios, reducing system complexity and cost.

The success or failure of the next wave of IoT devices will depend on the trust and security inherently built into those devices. Addressing those IoT device security needs is a primary focus of the K32W0x platform and its security features will assure confidentiality, integrity, and authenticity of the IoT device and its data.



Take advantage of the robust enablement package that includes the Bluetooth 5 host stack, Generic FSK and Thread protocol stacks, drivers, RTOS, development tools and support both complimentary and professional IDEs.

ENABLEMENT

- FRDM-K32W042 Freedom development board
- Bluetooth 5 host stack and application profiles
- Generic FSK at 250, 500, 1000 and 2000 kbit/s
- ▶ Thread IP-based network stack
- Support for NXP's MCUXpresso and IAR Embedded Workbench[®] IDEs
- Full integration with NXP's MCUXpresso SDK
- Support for multiple RTOSes including FreeRTOS™

K32W0x WIRELESS MCU PLATFORM BLOCK DIAGRAM



ORDERABLE PART NUMBERS

Product		Memory		Radio			Package	
Part Number	Marking	Flash (MB)	SRAM (kB)	Bluetooth LE	GENFSK	802.15.4	Pin Count	Package
K32W042S1M2VPJAT	K32W042S1M2VPJA	1.25	384	✓	~	~	176	9x9 mm VFBGA
K32W032S1M2VPJAT	K32W032S1M2VPJA			✓	✓			
K32W022S1M2VPJAT	K32W022S1M2VPJA					~		
K32W042S1M2CAVAR	K32W042S1M2CAVA	1.25	384	✓	✓	~	191	5.97x5.85 mm WLCSP
K32W032S1M2CAVAR	K32W032S1M2CAVA			✓	~			

K32W0x MCU PLATFORM

Features	Benefits				
Dual-core architecture with 72 MHz Cortex- M4F and Cortex-M0+ cores	Ideal for applications that require a high performance host processor to run the application and a low-power processor for radio and sensor operations				
Large on-chip memory with 1.25 MB flash and 384 kB SRAM	Fit both custom application code and wireless connectivity protocol stack(s) reducing complex two-chip solutions to a single device				
High security	Resource Domain Controller for access control, system memory protection and peripheral isolation				
	 Cryptographic sub-system that includes a dedicated core, dedicated instruction memory (IRAM and IROM) and dedicated data RAM for autonomous implementation of encryption, signing, and hashing algorithms including AES, DES, SHA, RSA and ECC 				
	Secure Key Management for storing and protecting sensitive security keys				
	• Wiping of the crypto sub-system memory including security keys upon sensing a security breach or physical tamper event				
Secure Boot/Update	Built in secure boot and secure over-the-air programming to assure only authorized and authenticated code runs in the device				
Multi-protocol radio	On-chip radio supporting Bluetooth 5, Generic FSK (up to 2 Mbps) and 802.15.4 for running Thread. Device supports concurrent (time slice) operations reducing costs of having to procure separate devices, reducing BOM and form-factor				
-96 dBm typical Bluetooth LE sensitivity	High link budget improves range and lowers cost by reducing the need for external power amplifiers				
-100 dBm typical 802.15.4 sensitivity +3.5 dBm maximum output power	Integrated balun enables smaller design and reduces system costs				
Power Management	Supports a wide-range of battery technologies				
	DCDC converter reduces the effective current consumption over standard bypass mode				
	Core voltage bypass for designs using external PMIC for improved power efficiency				
	Supports dual independent IO rails				
Analog	High-performance on-chip analog (ADC, DAC, CMP) for sensor aggregation and other sophisticated applications				
Small, high pin-count packages	Large IO capability in two small form-factor 176VFBGA and 191WLCSP packages				
Complete enablement	Full suite of standalone and multi-protocol connectivity stacks (complimentary and royalty free), hardware development tools, drivers, RTOS, integrated into NXPs MCUXpresso SDK				

www.nxp.com/K32W0x

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